

P-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)	
- 8	0.122 at V _{GS} = - 4.5 V	1.2		
	0.141 at V _{GS} = - 2.5 V	1.1	5.91	
	0.168 at V _{GS} = - 1.8 V	0.60	5.91	
	0.198 at V _{GS} = - 1.5 V	0.50		

FEATURES

 Halogen-free According to IEC 61249-2-21 Definition

Compliant to RoHS Directive 2002/95/EC

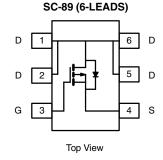
- TrenchFET[®] Power MOSFET
- 100 % R_q Tested

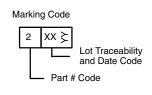


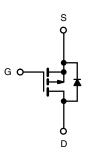
ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

• Load Switch for Portable Applications







Ordering Information: Si1051X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unle	ess otherwise no	oted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 8	V
Gate-Source Voltage		V _{GS}	± 5	v
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	,	1.2 ^{b, c}	
	T _A = 70 °C	I _D	0.97 ^{b, c}	А
Pulsed Drain Current		I _{DM}	- 8	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.2 ^{b, c}	А
Mariana Barra Biraina in a	T _A = 25 °C	PD	0.236 ^{b, c}	W
Maximum Power Dissipation ^a	T _A = 70 °C] 'D	0.151 ^{b, c}	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Marrian una lumation de Ambiento d	t ≤ 5 s	B	440	530	°C/W	
Maximum Junction-to-Ambient ^{b, d}	Steady State	R _{thJA}	540	650	- C/VV	

Notes:

- a. Based on $T_A = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 650 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 8			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 050 ::A		- 6.19		V/9C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -250 \mu A$		2.13		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.3		- 1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = - 8 V, V _{GS} = 0 V			- 1	nA	
	I _{DSS}	$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 8			Α	
_		V _{GS} = - 4.5 V, I _D = - 1.2 A		0.091	0.122	Ω	
	Ъ	V _{GS} = - 2.5 V, I _D = - 1.1A		0.106	0.141		
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	V _{GS} = - 1.8 V, I _D = - 0.60 A		0.117	0.168		
		V _{GS} = - 1.5 V, I _D = - 0.50 A		0.129	0.198		
Forward Transconductance	9 _{fs}	V _{DS} = - 4 V, I _D = - 1.2 A		4.93		S	
Dynamic ^b							
Input Capacitance	C _{iss}			560		pF	
Output Capacitance	C _{oss}	V _{DS} = - 4 V, V _{GS} = 0 V, f = 1 MHz		180			
Reverse Transfer Capacitance	C _{rss}			112			
·		V _{DS} = - 4 V, V _{GS} = - 5 V, I _D = - 1.2 A		6.3	9.45		
Total Gate Charge	Q_g			5.91	8.87	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -4 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.2 \text{ A}$		1.98			
Gate-Drain Charge	Q _{gd}			1.25			
Gate Resistance	R_{g}	f = 1 MHz		9.8	14.7	Ω	
Turn-On Delay Time	t _{d(on)}			7.2	10.8		
Rise Time	t _r	$V_{DD} = -4 \text{ V, R}_{L} = 4.16 \Omega$		36	54	ns	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -0.96 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		52	78		
Fall Time	t _f			16	24		
Drain-Source Body Diode Characteris	tics			'	! 		
Pulse Diode Forward Current ^a	I _{SM}				- 8	Α	
Body Diode Voltage	V _{SD}	I _S = - 1.0 A		0.8	1.2	٧	
Body Diode Reverse Recovery Time	t _{rr}			18.8	28.2	nC	
Body Diode Reverse Recovery Charge	Q _{rr}	1 10 0 11/44 100 0 4/55		4.7	7.05		
Reverse Recovery Fall Time	t _a	– I _F = - 1.0 A, dl/dt = 100 A/μs		15		ns	
Reverse Recovery Rise Time	t _b			3.8			

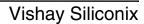
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

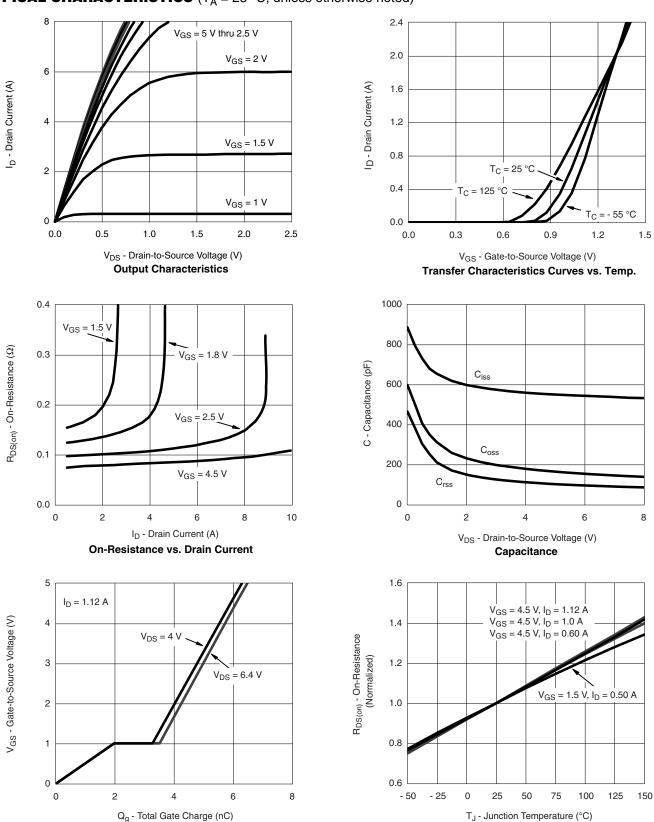
b. Guaranteed by design, not subject to production testing.







TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Gate Charge

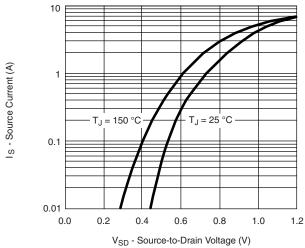
T_J - Junction Temperature (°C)

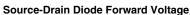
On-Resistance vs. Junction Temperature

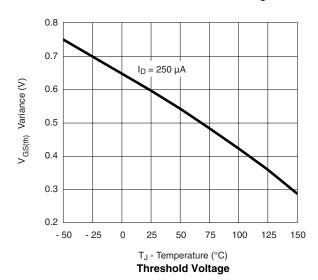
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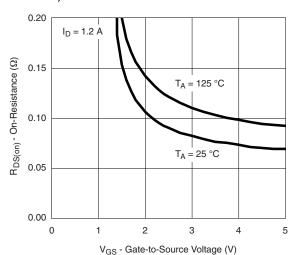
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TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)

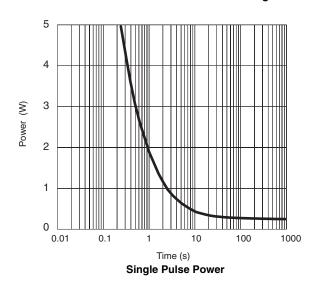


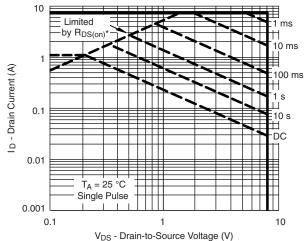






On-Resistance vs. Gate-to-Source Voltage





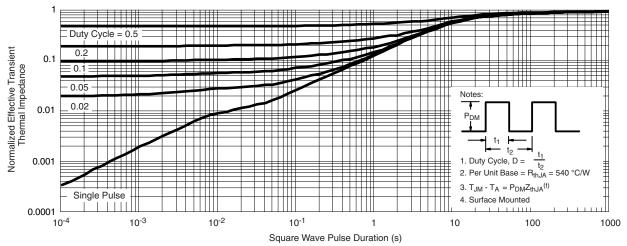
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

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